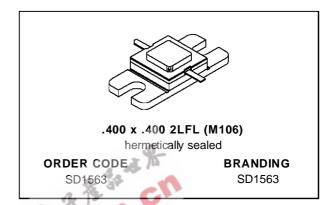


## **SD1563**

# RF & MICROWAVE TRANSISTORS UHF PULSED APPLICATIONS

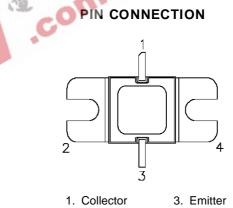
- 350 WATTS @ 10µSEC PULSE WIDTH, 10% DUTY CYCLE
- 300 WATTS @ 250µSEC PULSE WIDTH, 10% DUTY CYCLE
- 9.5 dB MIN. GAIN
- REFRACTORY GOLD METALLIZATION
- EMITTER BALLASTING AND LOW THERMAL RESISTANCE FOR RELIABILITY AND RUGGEDNESS
- INFINITE VSWR CAPABILITY AT SPECIFIED OPERATING CONDITIONS





#### **DESCRIPTION**

The SD1563 is a gold metallized silicon NPN pulse power transistor. The SD1563 is designed for applications requiring high peak power and low duty cycles within the frequency range of 400 - 500 MHz.



- 2. Base
- 4. Base

#### **ABSOLUTE MAXIMUM RATINGS** $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	65	V
$V_{CES}$	Collector-Emitter Voltage	65	V
V <sub>EBO</sub>	Emitter-Base Voltage	3.5	V
Ic	Device Current	21.6	Α
P <sub>DISS</sub>	Power Dissipation	875	W
TJ	Junction Temperature	+200	°C
T <sub>STG</sub>	Storage Temperature	- 65 to +150	°C

#### THERMAL DATA

R <sub>TH(j-c)</sub> Junction-Case Thermal Resistance	0.2	°C/W
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### SD1563

#### **ELECTRICAL SPECIFICATIONS** (Tcase = 25°C)

#### **STATIC**

Symbol	Test Conditions		Value			Unit	
Symbol			Min.	Тур.	Max.	Oiiit	
ВУсво	I <sub>C</sub> = 50 mA	$I_E = 0 \text{ mA}$		65	_		V
BVces	Ic = 50 mA	$V_{BE} = 0 V$		65	_		V
BV <sub>CEO</sub>	I <sub>C</sub> = 50 mA	$I_B = 0 \text{ mA}$		28	_		V
BV <sub>EBO</sub>	I <sub>E</sub> = 10 mA	$I_C = 0 \text{ mA}$		3.5	_		V
Ices	V <sub>CE</sub> = 30 V	$I_E = 0 \text{ mA}$		_	_	7.5	mA
h <sub>FE</sub>	V <sub>CE</sub> = 5 V	Ic = 5 A	·	10	_	100	_

#### **DYNAMIC**

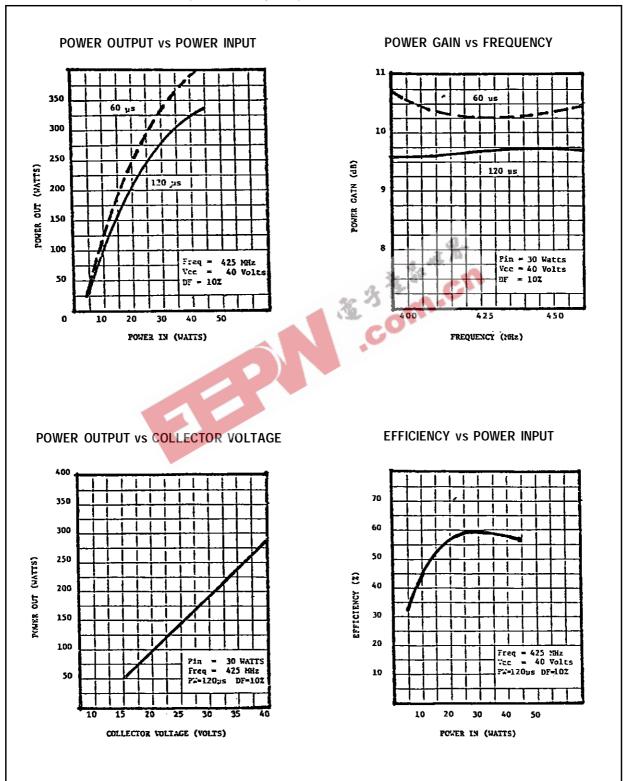
DYNAMIC				2_			
Symbol		Test Conditions	3.15	Value		Unit	
Symbol		rest Conditions	1 30 an	Min.	Тур.	Max.	
Pout	f = 425 MHz	$P_{IN} = 33.5 \text{ W}$	V <sub>CE</sub> = 40 V	300	_		W
PG	f = 425 MHz	P <sub>OUT</sub> = 300 W	$V_{CE} = 40 \text{ V}$	9.5	_		dB
ης	f = 425 MHz	P <sub>IN</sub> = 25 W	V <sub>CE</sub> = 40 V	55	_	_	%

Note: Pulse Width =  $250\mu$ Sec, Duty Cyle = 10%

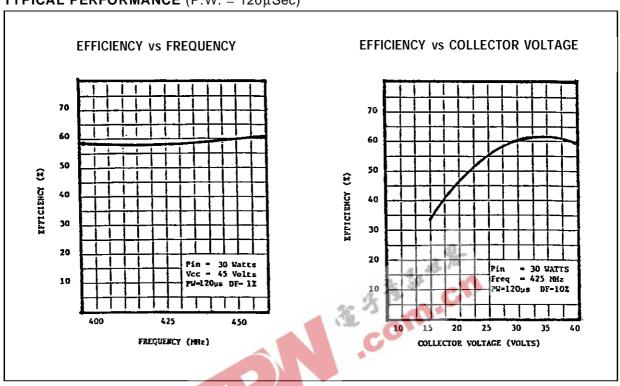
#### TYPICAL PERFORMANCE

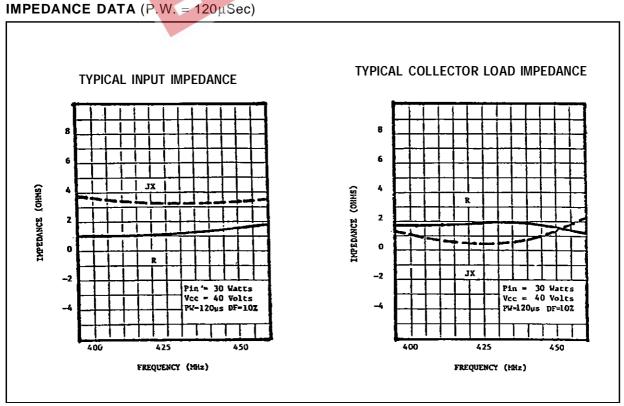
P <sub>OUT</sub> (W)	P.W. (μSec)	D.C. (%)	T <sub>J</sub> (°C max.)	Vcc
360	10	10	150	40
350	20	10	150	40
325	100	10	150	40
310	500	10	150	40
300	1000	10	150	40

#### **TYPICAL PERFORMANCE** (P.W. = $120\mu$ Sec)

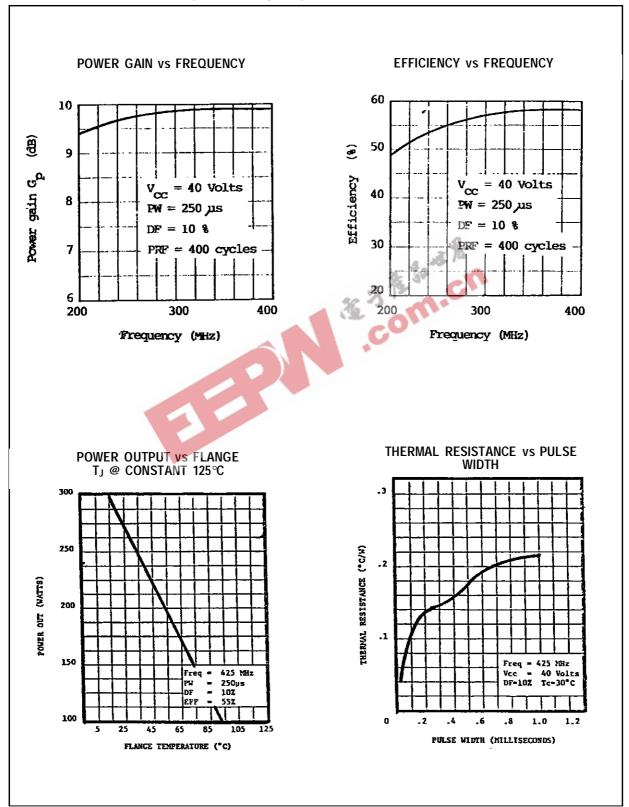


#### TYPICAL PERFORMANCE (P.W. = $120\mu Sec$ )

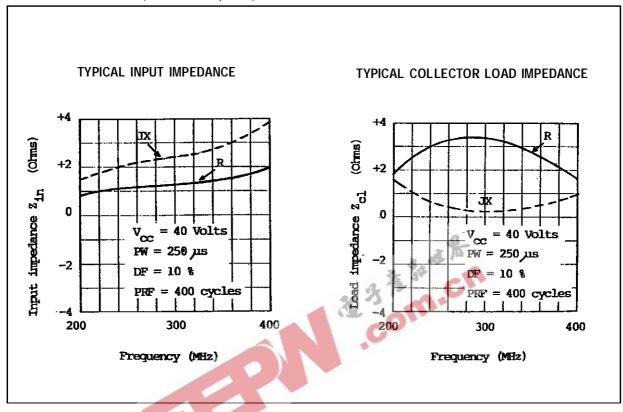




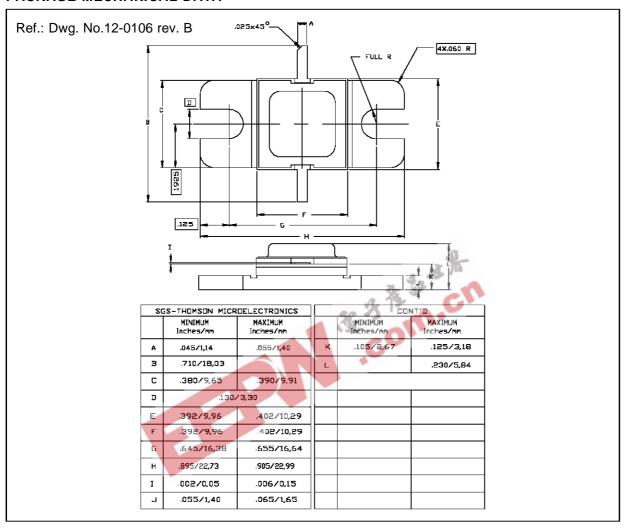
#### **TYPICAL PERFORMANCE** (P.W. = $250\mu$ Sec)



#### IMPEDANCE DATA (P.W. = $250\mu Sec$ )



#### **PACKAGE MECHANICAL DATA**



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